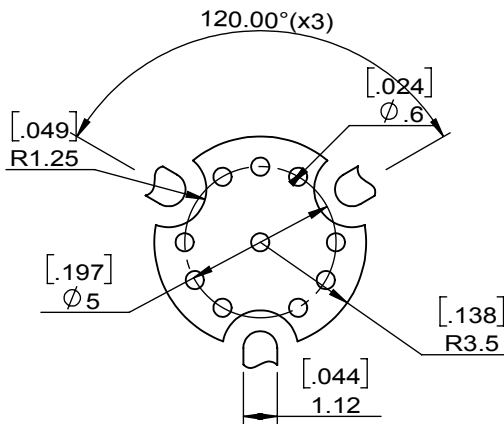
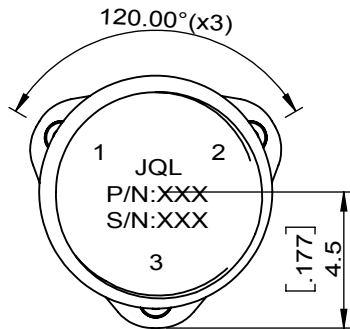
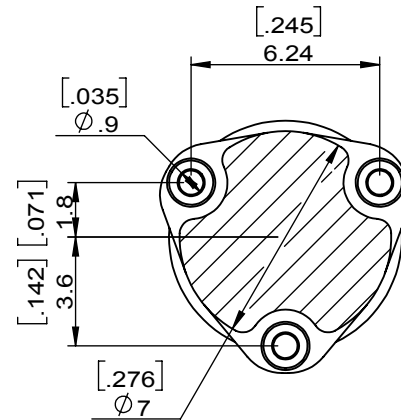
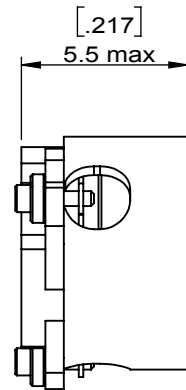
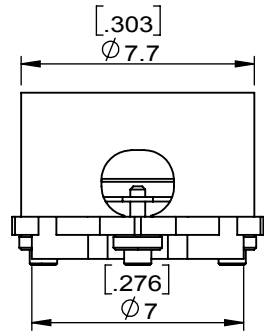
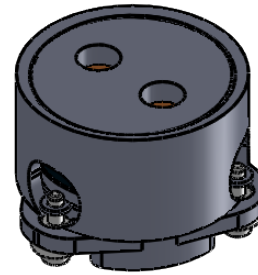
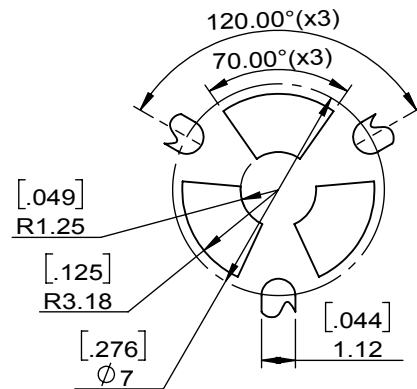


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Document No.	QR4-700-T-003
REV.	A/0

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REV.	DESCRIPTION	REVISOR	DATE	APPROVED
0		Hu.Jiang	07.31.2020	HC.Qiu



Copper Pattern



Soldermask Pattern

SPECIFICATIONS	
Part's Number	JCM2110T2170LM1R
Frequency(GHz)	2.110~2.170
Direction	CW
Insertion Loss(dB)MAX	0.4@+25°C 0.45@-40+100°C
Isolation(dB)MIN	20@+25°C 18.0@-40~+100°C
Return Loss(dB)MIN	20@+25°C 18.0@-40~+100°C
3rd IMD(dBc)MAX	-55@2X37dBm
Power FWD/REV/PK(Watt)	10/10/-
Operating Temperature(°C)	-40~+100
Storage Temperature(°C)	-
2nd/3rd Harmonic(dBc)	
Additional Notes	

JQL JQL Technologies Corporation				
MATERIAL: STEEL		DWG NO: JCM2110T2170LM1R		
SURFACE TREATMENT: SILVER PLATING		DWG BY:	Hu.Jiang	07.31.2020
DESCRIPTION: SMT CIRCULATOR		CHK'D BY:		SCALE
		APPV'D BY:		4:1
		Unit: mm[inch]	Tolerance: Liner: ±0.25 Anguar: ±0.5°	The First:
				A4



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WEIGHT: